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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	10MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	14
Program Memory Size	512B (512 x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8pe002hz010sg

PIN DESCRIPTION

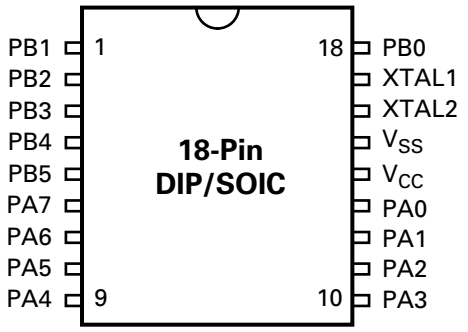

Figure 3. 18-Pin DIP/SOIC Pin Identification

Table 1. Standard Programming Mode

Pin #	Symbol	Function	Direction
1–5	PB1–PB5	Port B, Pins 1,2,3,4,5	Input/Output
6–9	PA7–PA4	Port A, Pins 7,6,5,4	Input/Output
10–13	PA3–PA0	Port A, Pins 3,2,1,0	Input/Output
14	V_{CC}	Power Supply	
15	V_{SS}	Ground	
16	XTAL2	Crystal Oscillator Clock	Output
17	XTAL1	Crystal Oscillator Clock	Input
18	PB0	Port B, Pin 0	Input/Output

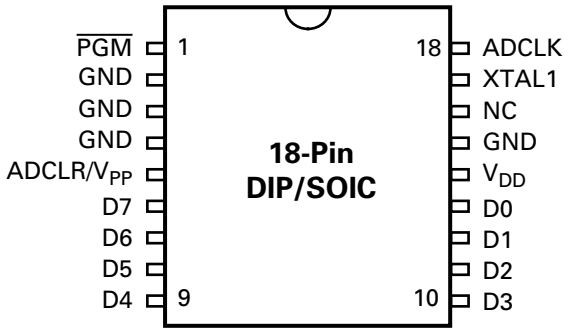

Figure 4. 18-Pin DIP/SOIC Pin Identification

Table 2. EPROM Programming Mode

Pin #	Symbol	Function	Direction
1	$\overline{PGM}$	Program Mode	Input
2–4	GND	Ground	
5	ADCLR/V_{PP}	Clear Clock/Program Voltage	Input
6–9	D7–D4	Data 7,6,5,4	Input/Output
10–13	D3–D0	Data 3,2,1,0	Input/Output
14	V_{DD}	Power Supply	
15	GND	Ground	
16	NC	No Connection	
17	XTAL1	1-MHz Clock	Input
18	ADCLK	Address Clock	Input

STANDARD TEST CONDITIONS

The characteristics listed below apply for standard test conditions as noted. All voltages are referenced to Ground. Positive current flows into the referenced pin (Figure 7).

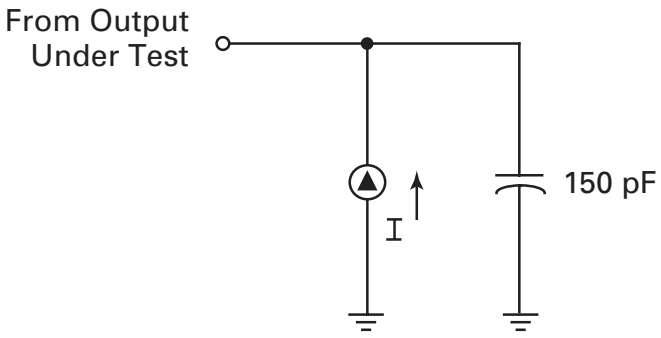

Figure 7. Test Load Diagram

CAPACITANCE

T_A = 25°C, V_{CC} = GND = 0V, f = 1.0 MHz, unmeasured pins returned to GND.

Parameter	Min	Max
Input capacitance	0	12 pF
Output capacitance	0	12 pF
I/O capacitance	0	12 pF

Table 6. DC Electrical Characteristics (Continued)

			T_A = –40°C to +105°C Extended Temperatures					
Sym	**Parameter**	**V_{CC}[1]**	**Min**	**Max**	**Typical[2] @ 25°C**	**Units**	**Conditions**	**Notes**
I_{CC1}	Standby Current	4.5V		2.0	1.0	mA	HALT mode V_{IN} = 0V, V_{CC} @ 10 MHz	5,6
		5.5V		2.0	1.0	mA	HALT mode V_{IN} = 0V, V_{CC} @ 10 MHz	5,6
I_{CC2}	Standby Current	4.5V		700	250	nA	STOP mode V_{IN} = 0V,V_{CC}	7
		5.5V		700	250	nA	STOP mode V_{IN} = 0V,V_{CC}	7

Notes:
1. The V_{CC} voltage specification of 4.5V and 5.5V guarantees 5.0V ±0.5V.
2. Typical values are measured at V_{CC} = 5.0V; V_{SS} = 0V = GND.
3. For analog comparator input when analog comparator is enabled.
4. No protection diode is provided from the pin to V_{CC}. External protection is recommended.
5. All outputs are unloaded and all inputs are at V_{CC} or V_{SS} level.
6. CL1 = CL2 = 22 pF.
7. Same as note 5, except inputs are at V_{CC}.

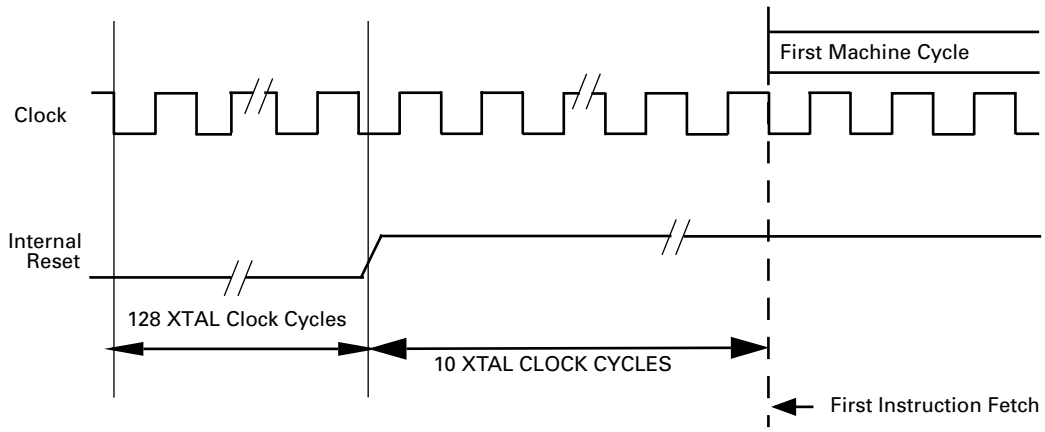

Figure 9. Reset Timing

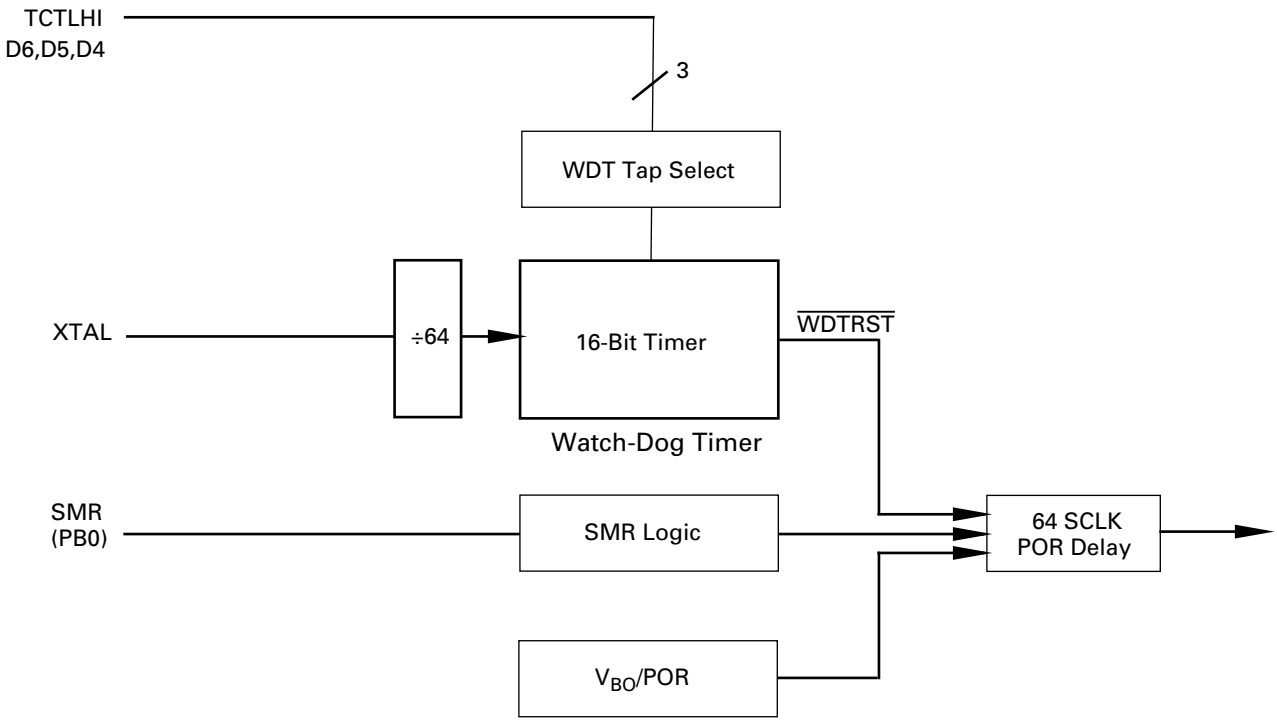

Figure 10. Reset Circuitry with POR, WDT, V_{BO}, and SMR

Table 11. Interrupt Mask Register—IMASK (FBh)

Bit	7	6	5	4	3	2	1	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
R = Read W = Write X = Indeterminate U = Undefined/ Undetermined								

Bit Position	R/W	Value	Description
7		0 1	Disables Interrupts Enables Interrupts
6		0	Reserved, must be 0
5		0 1	Disables IRQ5 Enables IRQ5
4		0 1	Disables IRQ4 Enables IRQ4
3		0 1	Disables IRQ3 Enables IRQ3
2		0 1	Disables IRQ2 Enables IRQ2
1		0 1	Disables IRQ1 Enables IRQ1
0		0 1	Disables IRQ0 Enables IRQ0

Interrupt Request (IREQ) Register Initialization

IREQ (Table 12) is a register that stores the interrupt requests for both vectored and polled interrupts. When an interrupt is issued, the corresponding bit position in the register is set to 1. Bits 0 to 5 are assigned to interrupt requests IREQ0 to IREQ5, respectively.

Whenever RESET is executed, the IREQ resistor is set to 00h.

Table 12. Interrupt Request Register–IREQ (FAh)

Bit	7	6	5	4	3	2	1	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
R = Read W = Write X = Indeterminate U = Undefined/ Undetermined								

Bit Position	R/W	Value	Description
7	R/W	0	Reserved, must be 0
6	R/W	0	Reserved, must be 0
5	R/W	0 1	IRQ5 reset IRQ5 set
4	R/W	0 1	IRQ4 reset IRQ4 set
3	R/W	0 1	IRQ3 reset IRQ3 set
2	R/W	0 1	IRQ2 reset IRQ2 set
1	R/W	0 1	IRQ1 reset IRQ1 set
0	R/W	0 1	IRQ0 reset IRQ0 set

IREQ SOFTWARE INTERRUPT GENERATION

IREQ can be used to generate software interrupts by specifying IREQ as the destination of any instruction referencing the Z8Plus Standard Register File. These software interrupts (SWI) are controlled in the same manner as hardware generated requests. In other words, the IMASK controls the enabling of each SWI.

To generate a SWI, the request bit in IREQ is set by the following statement:

```
OR IREQ,#NUMBER
```

The immediate data variable, NUMBER, has a 1 in the bit position corresponding to the required level of SWI. For example, an SWI must be issued when an IREQ5 occurs. Bit 5 of NUMBER must have a value of 1.

```
OR IREQ, #00100000B
```

If the interrupt system is globally enabled, IREQ5 is enabled, and there are no higher priority requests pending, control is transferred to the service routine pointed to by the IREQ5 vector.

Note: Software may modify the IREQ register at any time. Care should be taken when using any instruction that modifies the IREQ register while interrupt sources are active. The software writeback always takes precedence over the hardware. If a software writeback takes place on the same cycle as an interrupt source tries to set an IREQ bit, the new interrupt is lost.

Nesting of Vectored Interrupts

Nesting vectored interrupts allows higher priority requests to interrupt a lower priority request. To initiate vectored interrupt nesting, perform the following steps during the interrupt service routine:

- PUSH the old IMASK on the stack
- Load IMASK with a new mask to disable lower priority interrupts
- Execute an EI instruction
- Proceed with interrupt processing
- Execute a DI instruction after processing is complete
- Restore the IMASK to its original value by POPing the previous mask from the stack
- Execute IRET

Depending on the application, some simplification of the above procedure may be possible.

RESET Conditions

The IMASK and IREQ registers initialize to 00h on RESET.

PROGRAMMABLE OPTIONS

EPROM Protect. When selecting the DISABLE EPROM PROTECT/ENABLE TESTMODE option, the user can read the software code in the program memory. ZiLOG's internal factory test mode, or any of the standard test mode methods, are useful for reading or verifying the code in the microcontroller when using an EPROM programmer. If the user should select the ENABLE EPROM PROTECT/DISABLE TESTMODE option, it is not possible to read the code using a tester, programmer, or any other standard method. As a result, ZiLOG is unable to test the EPROM memory at any time after customer delivery.

This option bit only affects the user's ability to read the code and has no effect on the operation of the part in an application. ZiLOG tests the EPROM memory before customer delivery whether or not the ENABLE EPROM PROTECT/DISABLE TESTMODE option is selected; ZiLOG provides a standard warranty for the part.

System Clock Source. When selecting the RC OSCILLATOR ENABLE option, the oscillator circuit on the microcontroller is configured to work with an external RC circuit. When selecting the Crystal/Other Clock Source option, the oscillator circuit is configured to work with an external crystal, ceramic resonator, or LC oscillator.

WATCH-DOG TIMER

The Watch-Dog Timer (WDT) is a retriggerable one-shot 16-bit timer that resets the device if it reaches its terminal count. The WDT is driven by the XTAL2 clock pin. To provide the longer time-out periods required in applications, the watch-dog timer is only updated every 64th clock cycle. When operating in the RUN or HALT modes, a WDT time-out reset is functionally equivalent to an interrupt vectoring the PC to 0020H, and setting the WDT flag to 1. Coming out of $\overline{\text{RESET}}$, the WDT is fully enabled with its time-out value set at minimum, unless otherwise programmed during the first instruction. Subsequent executions of the WDT instruction reinitialize the watch-dog timer registers (C2h and C3h) to their initial values as defined by bits D6, D5, and D4 of the TCTLHI register. The WDT cannot be disabled except on the first cycle after $\overline{\text{RESET}}$ and when the device enters STOP mode.

The WDT instruction should be executed often enough to provide some margin of time to allow the WDT registers to approach 0. Because the WDT time-out periods are relatively long, a WDT $\overline{\text{RESET}}$ occurs in the unlikely event that the WDT times out on exactly the same cycle that the WDT instruction is executed.

$\overline{\text{RESET}}$ clears both the WDT and SMR flags. A WDT time-out sets the WDT flag, and the STOP instruction sets the SMR flag. This function enables software to determine whether a WDT time-out or a return from STOP mode occurred. Reading the WDT and SMR flags does not reset the flag to 0; therefore, the user must clear the flag via software.

Note: Failure to clear the SMR flag can result in unexpected behavior.

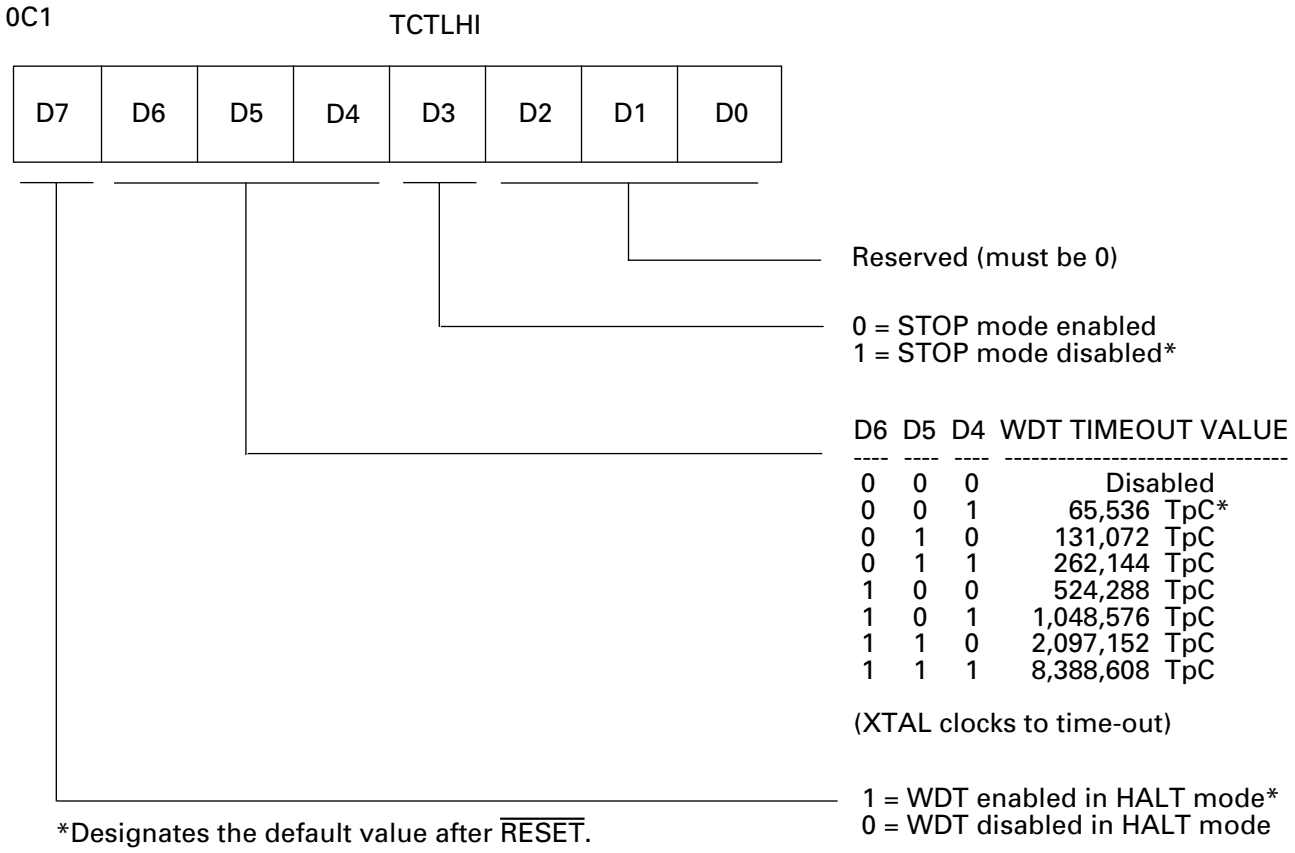

Figure 11. TCTLHI Register for Control of WDT

STOP MODE OPERATION

The STOP mode provides the lowest possible device stand-by current. This instruction turns off the on-chip oscillator and internal system clock.

To enter the STOP mode, the Z8Plus only requires a STOP instruction. It is *not* necessary to execute a NOP instruction immediately before the STOP instruction.

```
6F   STOP   ;enter STOP mode
```

The STOP mode is exited by any one of the following resets: POR or a Stop-Mode Recovery source. At reset generation, the processor always restarts the application program at address 0020H, and the STOP mode flag is set. Reading the STOP mode flag does not clear it. The user must clear the STOP mode flag with software.

Note: Failure to clear the STOP mode flag can result in undefined behavior.

The Z8Plus provides a dedicated Stop-Mode Recovery (SMR) circuit. In this case, a low-level applied to input pin PB0 (I/O Port B, bit 0) triggers an SMR. To use this mode, pin PB0 must be configured as an input and the special function selected before the STOP mode is entered. The Low level on PB0 must be held for a minimum pulse width T_{WSM}. Program execution starts at address 20h, after the POR delay.

Notes: 1. The PB0 input, when used for Stop-Mode Recovery, does not initialize the control registers.

The STOP mode current (I_{CC2}) is minimized when:

- V_{CC} is at the low end of the device's operating range
- Output current sourcing is minimized
- All inputs (digital and analog) are at the Low or High rail voltages

2. For detailed information about flag settings, see the Z8Plus User's Manual.

CLOCK

The Z8Plus MCU derives its timing from on-board clock circuitry connected to pins XTAL1 and XTAL2. The clock circuitry consists of an oscillator, a glitch filter, and a divide-by-two shaping circuit. Figure 12 illustrates the clock circuitry. The oscillator's input is XTAL1 and its output is XTAL2. The clock can be driven by a crystal, a ceramic resonator, LC clock, or an external clock source.

By selecting the RC OSCILLATOR option in the graphical user interface (GUI), the circuit may instead be driven by an external Resistor and Capacitor (RC) oscillator. Figure 13 illustrates this configuration. This design is limited to no more than 4 MHz to restrict EMI noise.

Note: The reduced drive strength of this configuration also allows the clock circuit to use a micropower-type crystal (also known as a tuning fork) without reduction resistors.

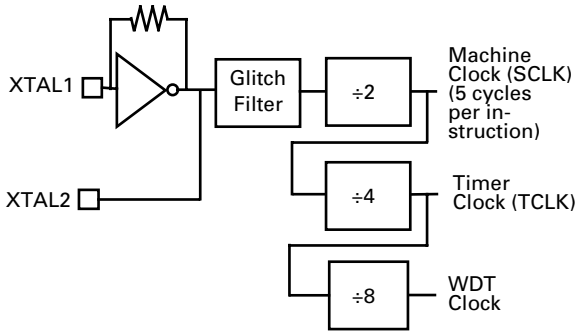

Figure 12. Clock Circuit

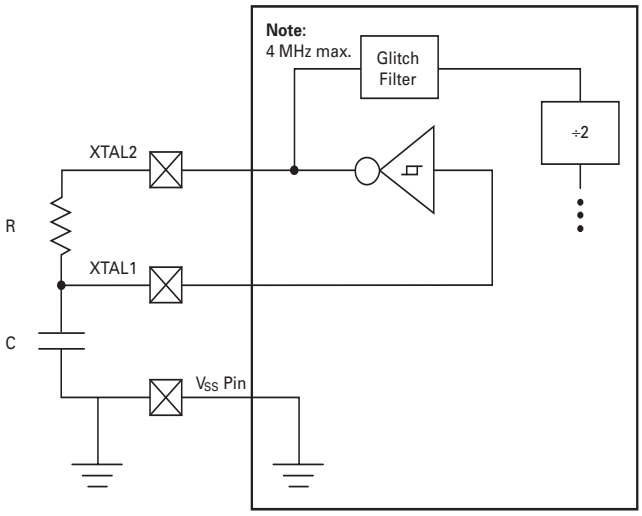

Figure 13. Z8Plus in RC Oscillator Mode

OSCILLATOR OPERATION

The Z8Plus MCU uses a Pierce oscillator with an internal feedback resistor (Figure 14). The advantages of this circuit are low-cost, large output signal, low-power level in the crystal, stability with respect to V_{CC} and temperature, and low impedances (not disturbed by stray effects).

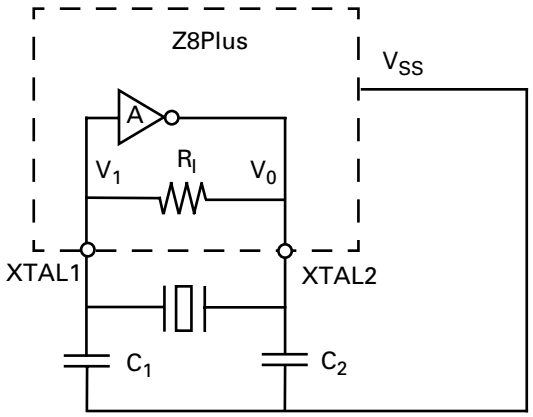

Figure 14. Pierce Oscillator with Internal Feedback Circuit

One drawback to the Pierce oscillator is the requirement for high gain in the amplifier to compensate for feedback path losses. The oscillator amplifies its own noise at start-up until it settles at the frequency that satisfies the gain/phase requirements. A x B = 1; where A = VO/VI is the gain of the amplifier, and B = VI/VO is the gain of the feedback element. The total phase shift around the loop is forced to 0 (360 degrees). V_{IN} must be in phase with itself; therefore, the amplifier/inverter provides a 180-degree phase shift, and the feedback element is forced to provide the other 180-degree phase shift.

R1 is a resistive component placed from output to input of the amplifier. The purpose of this feedback is to bias the amplifier in its linear region and provide the start-up transition.

Capacitor C2, combined with the amplifier output resistance, provides a small phase shift. It also provides some attenuation of overtones.

Capacitor C_1, combined with the crystal resistance, provides an additional phase shift.

Start-up time may be affected if C_1 and C_2 are increased dramatically in size. As C_1 and C_2 increase, the start-up time increases until the oscillator reaches a point where it ceases to operate.

For fast and reliable oscillator start-up over the manufacturing process range, the load capacitors should be sized as low as possible without resulting in overtone operation.

Layout

Traces connecting crystal, caps, and the Z8Plus oscillator pins should be as short and wide as possible to reduce parasitic inductance and resistance. The components (caps, the crystal, and resistors) should be placed as close as possible to the oscillator pins of the Z8Plus.

The traces from the oscillator pins of the integrated circuit (IC) and the ground side of the lead caps should be guarded from all other traces (clock, V_{CC}, address/data lines, and system ground) to reduce cross talk and noise injection. Guarding is usually accomplished by keeping other traces and system ground trace planes away from the oscillator circuit, and by placing a Z8Plus device V_{SS} ground ring around the traces/components. The ground side of the oscillator lead caps should be connected to a single trace to the Z8Plus device V_{SS} (GND) pin. It should not be shared with any other system-ground trace or components except at the Z8Plus device V_{SS} pin. The objective is to prevent differential system ground noise injection into the oscillator (Figure 15).

Indications of an Unreliable Design

There are two major indicators that are used in working designs to determine their reliability over full lot and temperature variations. They are:

Start-Up Time. If start-up time is excessive, or varies widely from unit to unit, there is probably a gain problem. To fix the problem, the C_1 and C_2 capacitors require reduction. The amplifier gain is either not adequate at frequency, or the crystal R's are too large.

Output Level. The signal at the amplifier output should swing from ground to V_{CC} to indicate adequate gain in the amplifier. As the oscillator starts up, the signal amplitude grows until clipping occurs. At that point, the loop gain is effectively reduced to unity, and constant oscillation is achieved. A signal of less than 2.5 volts peak-to-peak is an indication that low gain can be a problem. Either C_1 or C_2 should be made smaller, or a low-resistance crystal should be used.

OSCILLATOR OPERATION (Continued)

Circuit Board Design Rules

The following circuit board design rules are suggested:

- To prevent induced noise, the crystal and load capacitors should be physically located as close to the Z8Plus as possible.
- Signal lines should not run parallel to the clock oscillator inputs. In particular, the crystal input circuitry and the internal system clock output should be separated as much as possible.
- V_{CC} power lines should be separated from the clock oscillator input circuitry.
- Resistivity between XTAL1 or XTAL2 (and the other pins) should be greater than 10 meg-Ohms.

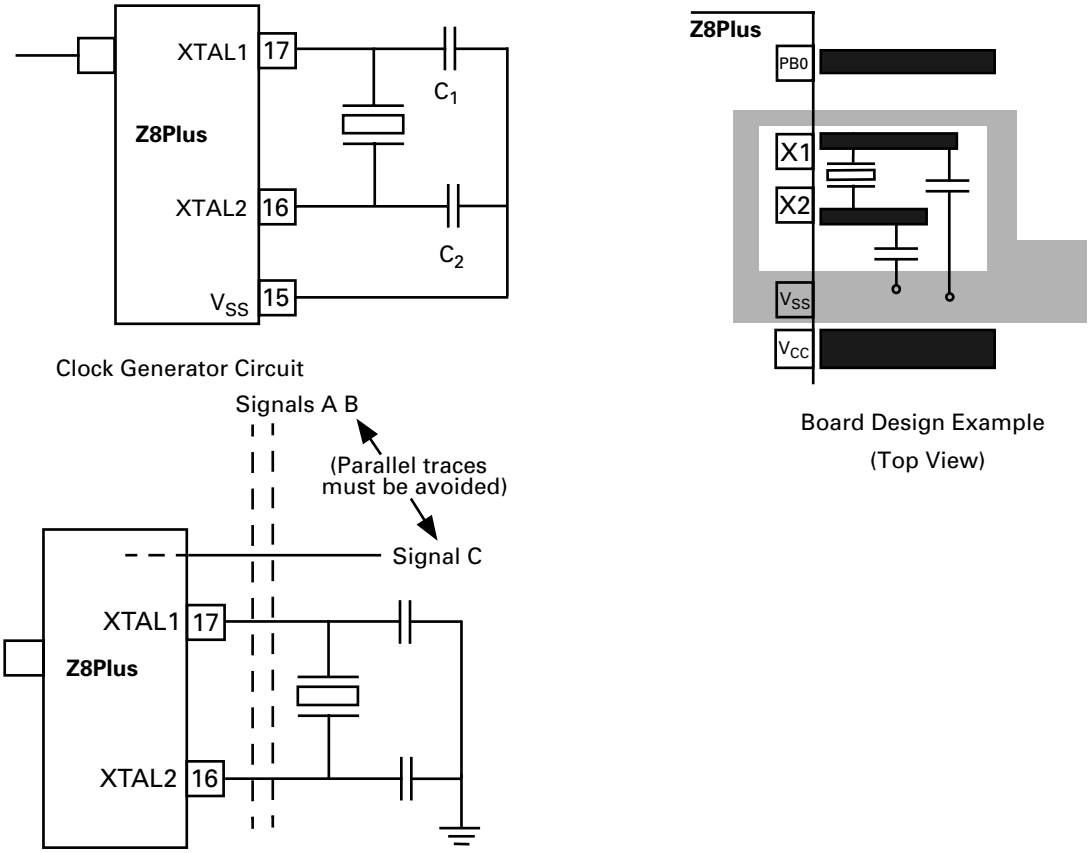

Figure 15. Circuit Board Design Rules

Crystals and Resonators

Crystals and ceramic resonators (Figure 16) should exhibit the following characteristics to ensure proper oscillation:

Crystal Cut	AT (crystal only)
Mode	Parallel, fundamental mode
Crystal Capacitance	<7pF
Load Capacitance	10pF < CL < 220 pF,
	15 typical
Resistance	100 Ohms maximum

Depending on the operation frequency, the oscillator may require additional capacitors, C_1 and C_2, as illustrated in Figure 16 and Figure 17. The capacitance values are dependent on the manufacturer's crystal specifications.

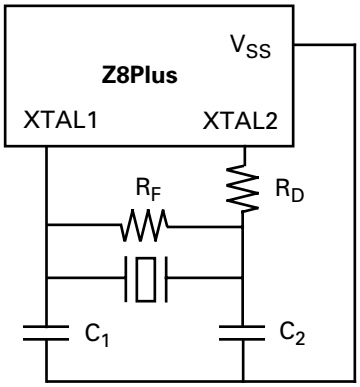

Figure 16. Crystal/Ceramic Resonator Oscillator

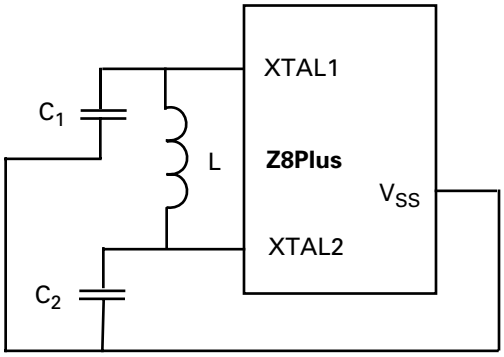

Figure 17. LC Clock

In most cases, the R_D is 0 Ohms and R_F is infinite. These specifications are determined and specified by the crystal/ceramic resonator manufacturer. The R_D can be increased to decrease the amount of drive from the oscillator output to the crystal. It can also be used as an adjustment to avoid clipping of the oscillator signal to reduce noise. The R_F can be used to improve the start-up of the crystal/ceramic resonator. The Z8Plus oscillator already locates an internal shunt resistor in parallel to the crystal/ceramic resonator.

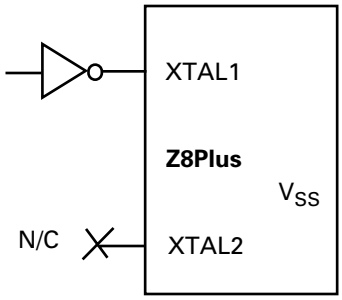

Figure 18. External Clock

Figure 16, Figure 17, and Figure 18 recommend that the load capacitor ground trace connect directly to the V_{SS} (GND) pin of the Z8Plus. This requirement assures that no system noise is injected into the Z8Plus clock. This trace should not be shared with any other components except at the V_{SS} pin of the Z8Plus.

Note: A parallel-resonant crystal or resonator manufacturer specifies a load capacitor value that is a series combination of C_1 and C_2, including all parasitics (PCB and holder).

TIMERS (Continued)

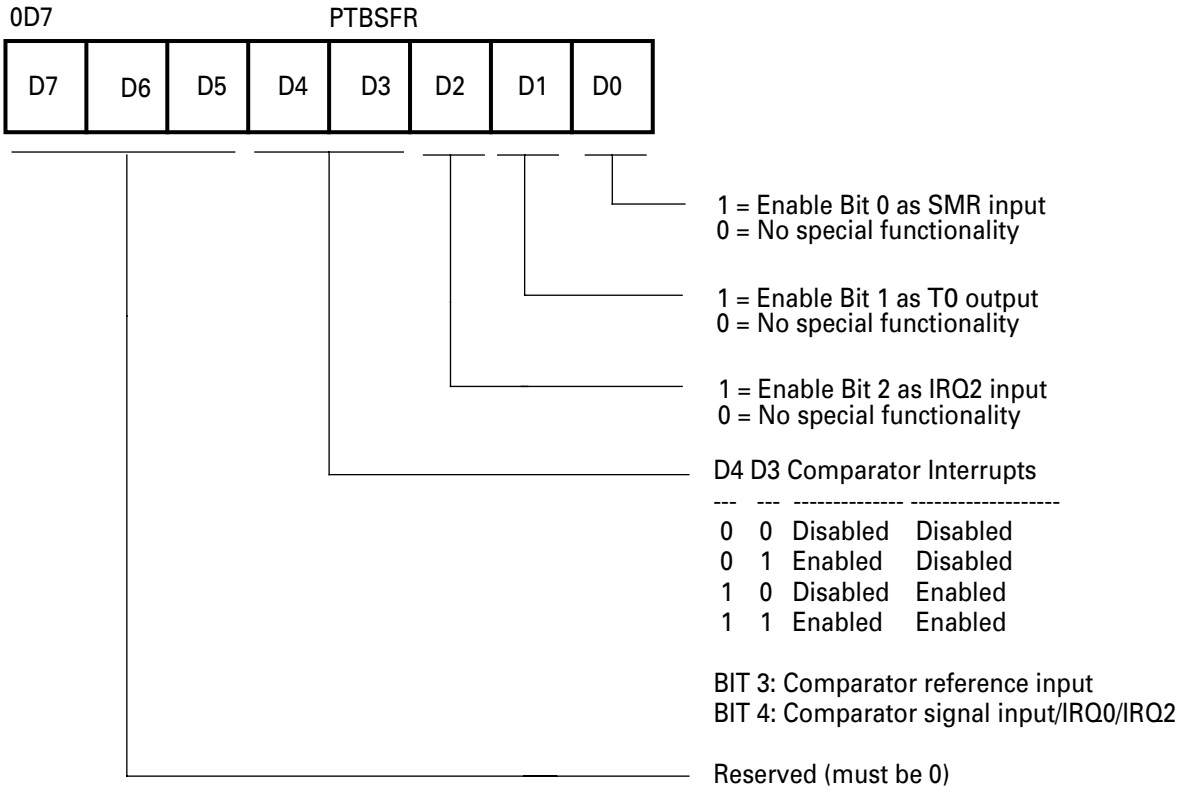

Figure 23. PortB Special Function Register

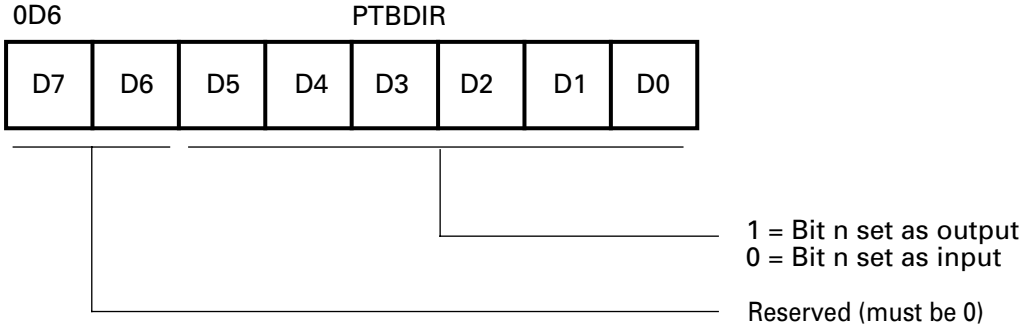

Figure 24. Port B Directional Control Register

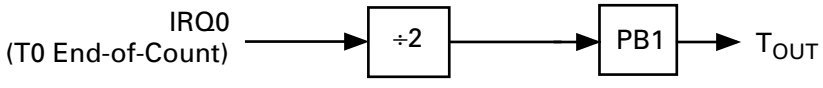

Figure 25. Timer T0 Output Through T_{OUT}

PORT B

Port B Description

Port B is a 6-bit (bidirectional), CMOS-compatible I/O port. These six I/O lines can be configured under software control to be an input or output. Each bit is configured independently from the other bits. That is, one bit may be set to INPUT while another bit is set to OUTPUT.

In addition to standard input/output capability, five pins of Port B provide special functionality as indicated in Table 15.

Table 15. Port B Special Functions

Port Pin	Input Special Function	Output Special Function
PB0	Stop Mode Recovery Input	None
PB1	None	T0 Output
PB2	IRQ3	None
PB3	Comparator Reference Input	None
PB4	Comparator Signal Input/IRQ1/IRQ4	None

Special functionality is invoked via the Port B special function register. Port B, bit 5, is an open-drain-only pin when in output mode. There is no high-side driver on the output stage, nor is there any high-side protection device, because PB5 acts as the V_{PP} pin for EPROM programming mode. The user should always place an external protection diode on this pin. See Figure 32.

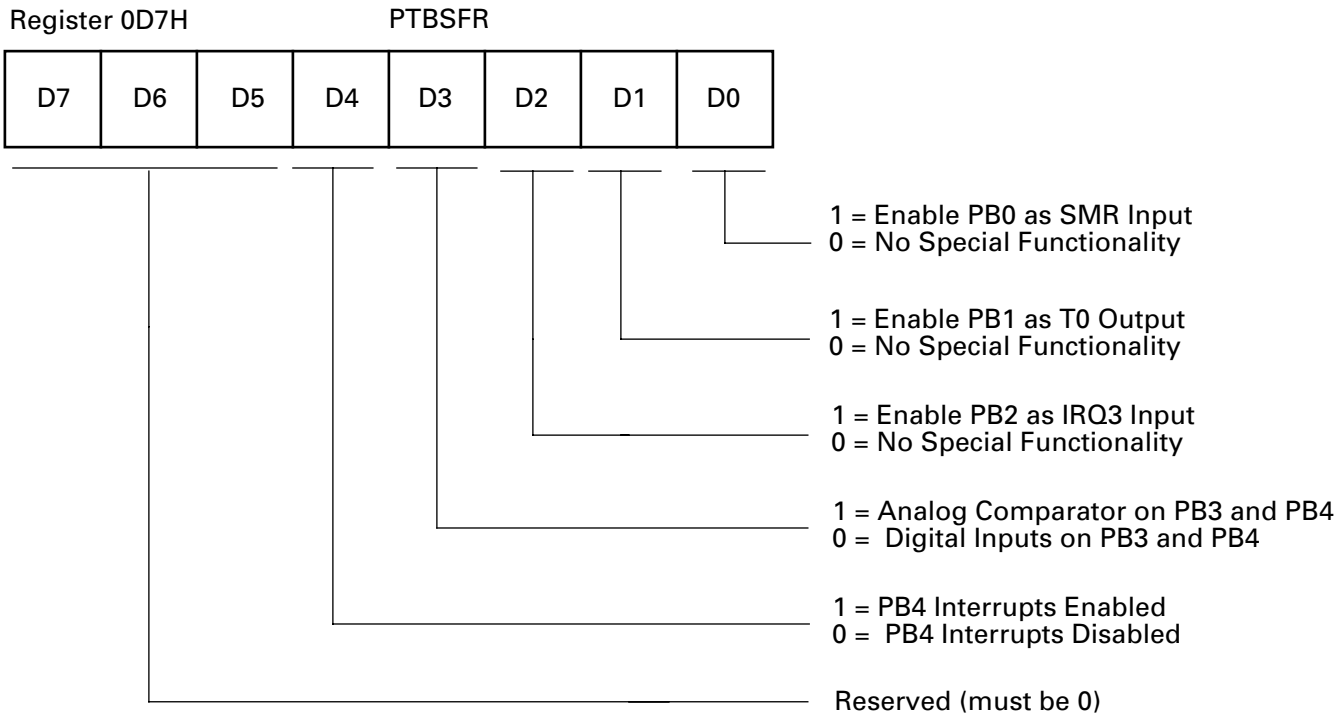

Figure 32. Port B Special Function Register

PORT B—PIN 2 CONFIGURATION

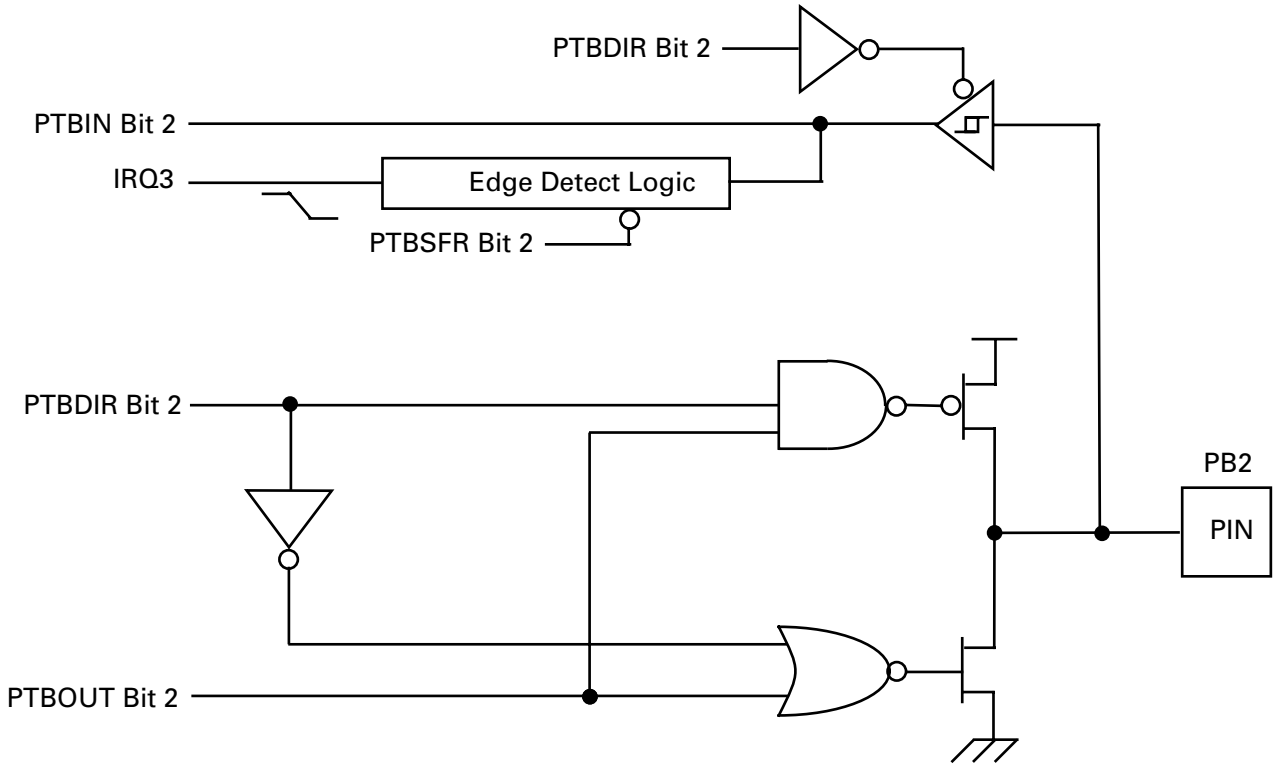

Figure 36. Port B Pin 2 Diagram

PORT B CONTROL REGISTERS

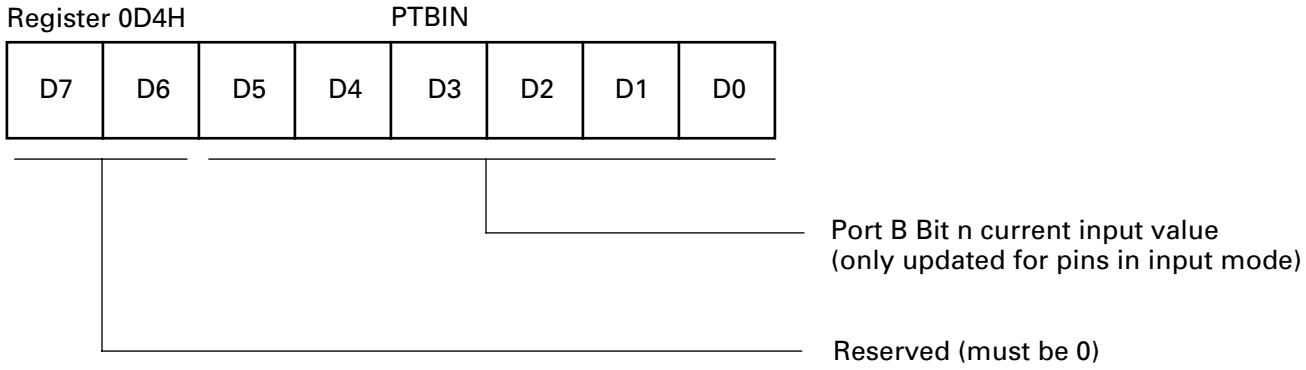

Figure 38. Port B Input Value Register

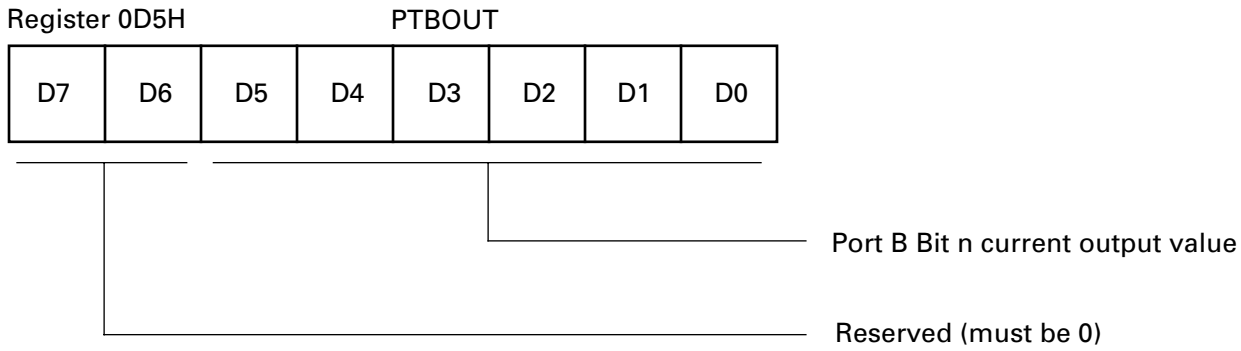

Figure 39. Port B Output Value Register

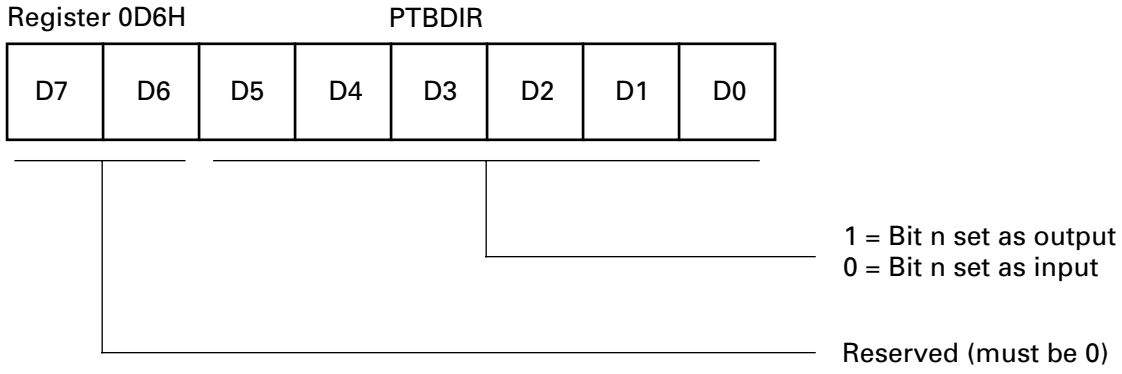

Figure 40. Port B Directional Control Register

PORT B CONTROL REGISTERS (Continued)

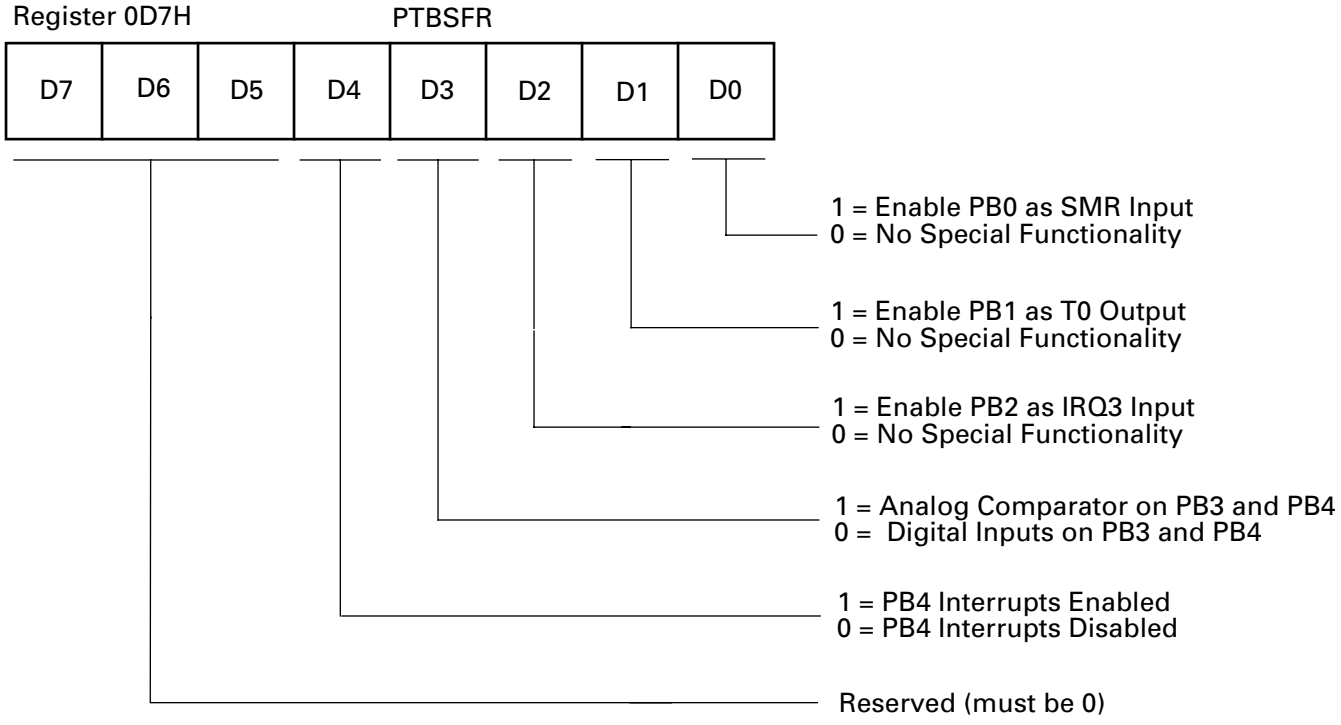

Figure 41. Port B Special Function Register

I/O PORT RESET CONDITIONS

Full Reset

Port A and Port B output value registers are not affected by $\overline{\text{RESET}}$.

On $\overline{\text{RESET}}$, the Port A and Port B directional control registers are cleared to all zeros, which defines all pins in both ports as inputs.

On $\overline{\text{RESET}}$, the directional control registers redefine all pins as inputs, and the Port A and Port B input value registers overwrites the previously held data with the current sample of the input pins.

On $\overline{\text{RESET}}$, the Port A and Port B special function registers are cleared to 00h, which deactivates all port special functions.

Note: The SMR and WDT time-out events are *not* full device resets. The port control registers are not affected by either of these events.

ANALOG COMPARATOR

The device includes one on-chip analog comparator. Pin PB4 features a comparator front end. The comparator reference voltage is on pin PB3.

Comparator Description

The on-chip comparator can process an analog signal on PB4 with reference to the voltage on PB3. The analog function is enabled by programming the Port B special function register bits 3 and 4.

When the analog comparator function is enabled, bit 4 of the input register is defined as holding the synchronized output of the comparator, while bit 3 retains a synchronized sample of the reference input.

If the interrupts for PB4 are enabled when the comparator special function is selected, the output of the comparator generates interrupts.

COMPARATOR OPERATION

The comparator output reflects the relationship between the analog input to the reference input. If the voltage on the analog input is higher than the voltage on the reference input, then the comparator output is at a High state. If the voltage on the analog input is lower than the voltage on the reference input, then the analog output is at a Low state.

Comparator Definitions

V_{ICR}

The usable voltage range for the positive input and reference input is called the Comparator Input Common Mode Voltage Range (V_{ICR}).

Note: The comparator is not guaranteed to work if the input is outside of the V_{ICR} range.

V_{OFFSET}

The absolute value of the voltage between the positive input and the reference input required to make the comparator output voltage switch is the Comparator Input Offset Voltage (V_{OFFSET}).

I_{IO}

For the CMOS voltage comparator input, the input offset current (I_{IO}) is the leakage current of the CMOS input gate.

HALT Mode

The analog comparator is functional during HALT mode. If the interrupts are enabled, an interrupt generated by the comparator causes a return from HALT mode.

STOP Mode

The analog comparator is disabled during STOP mode. The comparator is powered down to prevent it from drawing any current.

Low Voltage Protection. An on-board Voltage Comparator checks that the V_{CC} is at the required level to ensure correct operation of the device. A reset is globally driven if V_{CC} is below the specified voltage (Low Voltage Protection).

The device functions normally at or above 3.0V under all conditions, and is guaranteed to function normally at supply voltages above the Low Voltage Protection trip point. Below 3.0V, the device functions normally until the Low Volt-

ORDERING INFORMATION

Standard Temperature	
18-Pin DIP	Z8PE002PZ010SC
18-Pin SOIC	Z8PE002SZ010SC
20-Pin SSOP	Z8PE002HZ010SC
Extended Temperature	
18-Pin DIP	Z8PE002PZ010EC
18-Pin SOIC	Z8PE002SZ010EC
20-Pin SSOP	Z8PE002CZ010EC

For fast results, contact your local ZiLOG sales office for assistance in ordering the part(s) required.

Codes	
Preferred Package	PZ = Plastic DIP
Longer Lead Time	SZ = SOIC
	HZ = SSOP
Speed	010 = 10 MHz
Standard Temperature	S = 0°C to +70°C
Extended Temperature	E = –40°C to +105°C
Environmental Flow	C = Plastic Standard

Example:

The Z8PE002PZ010SC is a 10-MHz DIP, 0ºC to 70ºC, with Plastic Standard Flow.

Z	ZiLOG Prefix
8PE	Z8Plus Product
002	Product Number
PZ	Package Designation Code
010	Speed
SC	Temperature and Environmental Flow

Pre-Characterization Product

The product represented by this document is newly introduced and ZiLOG has not completed the full characterization of the product. The document states what ZiLOG knows about this product at this time, but additional features or non-conformance with some aspects of the document may be found, either by ZiLOG or its customers in the course of further application and characterization work. In addition, ZiLOG cautions that delivery may be uncertain at times, due to start-up yield issues.

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